



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor: Borchert, Bernd

PATENT

Serial No: 09/944823

COPY OF PAPERS
ORIGINALLY FILED

Art Group Unit:

Filing Date: August 31, 2001

Examiner:

Title: Halbleiterlaserchip und Verfahren
zum Hartstelle eines
Halbleiterlaserchips

**FILING OF PRIORITY
DOCUMENT AND
TRANSLATION**

Honorable Commissioner of Patents
Washington, D.C. 20231

Dear Sir:

Enclosed herein please find the following documents relating to the referenced pending U.S. Patent Application:

1. Priority Document No. 100 42 904.1.
2. An accurate translation of the application in English. A check in the amount of \$130.00 pursuant to 37 C.F.R. §1.17(t) is enclosed.
3. Please charge any further amounts required by this filing to Deposit Account No. 02-3732 or credit any overpayments thereto.

EXTENSION OF TIME

Applicant believes that no time extension is necessary in order to make this response timely. Should Applicant be in error, Applicant respectfully requests such time extension as necessary to make this response timely and hereby authorizes the U.S. Patent and Trademark Office to charge Deposit Account 02-3732 for any necessary fees in respect to said time extension.

Respectfully submitted,
by their attorney,

Date: 11/5/2001

By: 

Craig Gregersen
Briggs and Morgan
2200 1st National Bank Building
332 Minnesota Street
St. Paul, MN 55101

CERTIFICATE OF MAILING UNDER 37 CFR 1.8: I hereby certify that this paper and any papers referred to herein are being deposited with the U.S. Postal Service, as first class mail, postage prepaid, addressed to the Commissioner of Patents and Trademarks, c/o Assistant Commissioner of Patents, Washington, D.C. 20231 on

Nov. 5, 2001



Signature



UNITED STATES PATENT AND TRADEMARK OFFICE

COMMISSIONER FOR PATENTS
UNITED STATES PATENT AND TRADEMARK OFFICE
WASHINGTON, D.C. 20231
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APPLICATION NUMBER	FILING/RECEIPT DATE	FIRST NAMED APPLICANT	ATTORNEY DOCKET NUMBER
09/944,823	JAN 18 2002 PATENT & TRADEMARK OFFICE	Bernd Borchert	32226 12

CONFIRMATION NO. 3378

FORMALITIES LETTER



OC000000006870546

Infineon Technologies North America Corp.
c/o Siemens Corporation
Intellectual Property Department
186 Wood Avenue South
Iselin, NJ 08830

Date Mailed: 10/09/2001

NOTICE TO FILE MISSING PARTS OF NONPROVISIONAL APPLICATION

FILED UNDER 37 CFR 1.53(b)

Filing Date Granted

An application number and filing date have been accorded to this application. The item(s) indicated below, however, are missing. Applicant is given **TWO MONTHS** from the date of this Notice within which to file all required items and pay any fees required below to avoid abandonment. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136(a).

- The oath or declaration is missing.
A properly signed oath or declaration in compliance with 37 CFR 1.63, identifying the application by the above Application Number and Filing Date, is required.
- To avoid abandonment, a late filing fee or oath or declaration surcharge as set forth in 37 CFR 1.16(l) of \$130 for a non-small entity, must be submitted with the missing items identified in this letter.
- The application was filed in a language other than English. Applicant is required to provide an English translation of the specification and a statement that the translation is accurate. (See 37 CFR 1.52(d)).
- Applicant must file an English translation of the application, the \$ 130 fee set forth in 37 CFR 1.17(i), unless previously submitted, and a statement that the translation is accurate (37 CFR 1.52(d)).
- **The balance due by applicant is \$ 260.**
- Because your specification was filed in a language other than English, the Office was unable to determine the number of claims submitted. Additional claim fees may be due once the number of claims can be determined

*A copy of this notice **MUST** be returned with the reply.*

Customer Service Center

Initial Patent Examination Division (703) 308-1202

PART 2 - COPY TO BE RETURNED WITH RESPONSE